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Fibre optic interconecting devices and passive components – Part 03-03: Reliability – Report on high-power reliability for metal-doped optical fibre plug-style optical attenuators

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CONTENTS

FOREWORD 4
INTRODUCTION 6
1 Scope 7
2 Normative references 7
3 Outline of high-power test for optical attenuators in IEC/TR 62627-03-02 7
4 Accuracy of the internal temperature estimated by the thermal simulation 8
5 Return loss decreasing test for plug-style optical attenuators 10
5.1 Test samples 10
5.2 Test set-up and test conditions 11
5.3 Test results and the analysis 12
5.3.1 The degradation on high-power condition 12
5.3.2 The result of permanent fibre withdrawals before and after the test 13
5.3.3 Stabilization time of return loss decreasing 15
5.3.4 Relation of optical input power, test temperature and stabilized return loss 15
6 Mechanism of fibre withdrawal on high-power condition 17
6.1 Estimate of the mechanism of fibre withdrawal 17
6.2 Fibre withdrawal after application of high-power test three times 18
7 Long-term reliability test 19
7.1 Test conditions 19
7.2 Test results 20
7.2.1 Return loss changing during the test 20
7.2.2 The performance deviation after the test 20
7.3 Analysis of long-term, high-power reliability test 20
8 Conclusion 20
Bibliography 22

Figure 1 – Split-sleeve surface temperature measurement system on high-power input condition for the SC plug style attenuators by Yamaguchi et al. 8
Figure 2 – Split sleeve out-surface temperature measurement results on high-power input condition for the SC plug style attenuators by Yamaguchi et al. 9
Figure 3 – Input-power dependency of split sleeve outer surface temperature of the SC plug style optical attenuator without housing 10
Figure 4 – Sample of design – Worst-case endface conditions 11
Figure 5 – Test set-up of return loss monitor at high-power input into the optical attenuator 11
Figure 6 – High-power input test results of optical attenuator 12
Figure 7 – Result of high-power input test of the optical attenuator 12
Figure 8 – Relationship between the gap and the return loss 13
Figure 9 – Distribution diagram of the optical fibre withdrawal of both the optical attenuator and the optical connector 14
Figure 10 – Temperature distribution along the central axis derived from thermal simulation (10 dB optical attenuator) 14
Figure 11 – Time dependence of the maximum temperature in thermal simulation of the optical attenuator 15

Figure 12 – Return loss decreasing curve in the tests with various test temperatures and input powers (sample no. ATT44/JC35) 16

Figure 13 – Relationship between the maximum internal temperature and return loss stabilization point of the sample tested with various test temperatures and input powers (sample no. ATT44/JC35) 16

Figure 14 – Relationship between the maximum internal temperature and the gap at stabilization of return loss of the sample tested with various test temperature and input powers (sample no. ATT44/JC35) 17

Figure 15 – Thermal stress simulation model for three layers of zirconia, epoxy and silica 17

Figure 16 – Result of thermal distortion simulation and relationship between the sample maximum internal temperature and the gap 18

Figure 17 – Optical fibre withdrawal alternation under repeated power input to the optical fixed attenuation (70 °C, 1 W, 30 min, repeated inputs) 19

Figure 18 – High-power, long-term test results of the optical attenuator 20

Table 1 – Test conditions of optical attenuators 12

Table 2 – Conditions for high-power, long-term test of the optical attenuator 19

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FIBRE OPTIC INTERCONECTING DEVICES AND PASSIVE COMPONENTS –

Part 03-03: Reliability – Report on high-power reliability for metal-doped optical fibre plug-style optical attenuators

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IEC 62627-03-03, which is a technical report, has been prepared by subcommittee 86B: Fibre optic interconnecting devices and passive components, of IEC technical committee 86: Fibre optics.

The text of this technical report is based on the following documents:

Enquiry draft	Report on voting
86B/3458/DTR	86B/3506/RVC

Full information on the voting for the approval of this technical report can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62627 series, published under the general title *Fibre optic interconnecting devices and passive components*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

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INTRODUCTION

Since 2000, the optical power in transmission systems has increased in conjunction with the increase in the number of channels for DWDM systems, with the help of deployment of RAMAN amplifiers and application of optical amplifiers. It is pointed out, however, that the transmission media of the optical transmission system such as the optical fibre, optical connector and optical passive components may sometimes be hazardous because of possible leakage of high-power light that results in personal injury, melting, or a damage possibly causing a fire.

IEC Japan National Committee (JPNC) and Optoelectronics Industry and Technology Development Association (OITDA) carried out the research on the high-power reliability and safety of optical passive components. The result was summarized in the OITDA Technical paper, TP04/SP-PD-2008 “Study on the High-Power Reliability of Optical Passive Parts for Communications.” IEC/TR 62627-03-02 was published based on the above report. According to that report, deterioration of optical passive components at high-power input is caused by temperature rise due to absorption of light as well as consequential thermal distortion. It was decided to undertake additional research whilst utilizing these findings, specifically on the plug style optical attenuator, whose resistance against high-power is relatively small. The study result was summarized in OITDA TP, TP09/SP-PD-2010.

This technical report was prepared on the basis of OITDA TP, TP09/SP-PD-2010,“*Technical paper of investigation of high-power reliability for plug-style fixed optical attenuators*”.

FIBRE OPTIC INTERCONECTING DEVICES AND PASSIVE COMPONENTS –

Part 03-03: Reliability – Report on high-power reliability for metal-doped optical fibre plug-style optical attenuators

1 Scope

IEC/TR 62627-03-03, which is a technical report, describes the investigation results of high-power reliability for metal-doped optical fibre plug-style attenuators.

This report contains the high-power test results for metal-doped optical fibre SC plug-style optical attenuators, the thermal simulation results and the analysis of degradation modes, long-term reliability test results under high-power conditions and the derivation of maximum limit of optical power for guaranteeing long-term operation.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC/TR 62627-03-02, *Fibre optic interconnecting devices and passive components – Part 03-02: Reliability – Report of high-power transmission test of specified passive optical components*